



C Series
Tight Tolerance Capacitors

Type: C1005 [EIA CC0402]

C1608 [EIA CC0603]

Issue date: January 2011

TDK MLCC US Catalog

Version A11

### **REMINDERS**

Please read before using this product

### SAFETY REMINDERS



### REMINDERS

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# **C** Series





## Tight Tolerance Capacitors

Type: C1005, C1608

Available Through Distribution Only\*

### Features



- · Available in 1% and 2% capacitance tolerance
- · Suitable for high frequency applications
- · A monolithic structure ensures superior mechanical strength and reliability
- · High-accuracy automatic mounting is facilitated through the maintenance of very precise dimensional tolerances
- · Composed of only ceramics and metals, these capacitors provide extremely dependable performance, exhibiting virtually no degradation even when subjected to temperature extremes
- · Low stray capacitance ensures high conformity with nominal values, thereby simplifying the circuit design
- · Low residual inductance assures superior frequency characteristics
- Owing to their low ESR and excellent frequency characteristics, these products are optimally suited for high frequency and high-density type power supplies

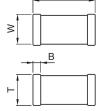
### **Applications**

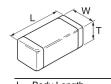


- · Electronics equipment
- · Mobile communications equipment
- · LTE/WiMAX base stations
- · High frequency RF modules
- · Test and measurement equipment
- · Matching/Coupling circuits
- Tuning circuits

# Shape &







Body Length Body Width

**Body Height** Terminal Width



### Part Number Construction

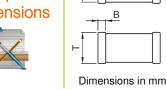
#### С 1608 COG 2A 102 F T XXXX **Series Name** Dimensions L x W (mm) Width **Case Code** Length C1005 1.00 ± 0.05 $0.50 \pm 0.05$ $0.80 \pm 0.10$ C1608 $1.60 \pm 0.10$ **Temperature Characteristic Temperature** Capacitance Temperature Characteristics Change Range 0±30 ppm/ºC -55 to +125°C Rated Voltage (DC) **Voltage Code** Voltage(DC) 1H 50V 100V Nominal Capacitance (pF)

The capacitance is expressed in three digit codes and in units of pico Farads (pF). The first and second digits identify the first and second significant figures of the capacitance. The third digit identifies the multiplier. R designates a decimal point.

### Capacitance Code Capacitance

0R5	0.5pF
010	1pF
102	1,000pF (1nF)
105	1,000,000pF (1µF)

### **Dimensions**



### Internal Codes

### **Packaging Style**

**Packaging Code** Style Tape and Reel

#### Capacitance Tolerance

Tolerance Code	Tolerance
F	± 1%
G	± 2%

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## C1005 [EIA CC0402]

Available Through Distribution Only\*

Class 1 (Temperature Compensating)

Temperature Characteristics: C0G (0 ± 30 ppm/°C)

TDK Part Number (Ordering Code)	Temperature Characteristics	Rated Voltage	Capacitance (pF)	Capacitance Tolerance	Thickness (mm)
C1005C0G1H220F	C0G	50V	22	1%	$0.50 \pm 0.05$
C1005C0G1H220G	COG	50V	22	2%	$0.50 \pm 0.05$
C1005C0G1H470F	COG	50V	47	1%	$0.50 \pm 0.05$
C1005C0G1H470G	COG	50V	47	2%	$0.50 \pm 0.05$
C1005C0G1H101F	C0G	50V	100	1%	$0.50 \pm 0.05$
C1005C0G1H101G	C0G	50V	100	2%	0.50 ± 0.05



### C1608 [EIA CC0603]

Available Through Distribution Only\*

Class 1 (Temperature Compensating)

Temperature Characteristics: C0G (0 ± 30 ppm/°C)

TDK Part Number (Ordering Code)	Temperature Characteristics	Rated Voltage	Capacitance (pF)	Capacitance Tolerance	Thickness (mm)
C1608C0G1H220F	C0G	50V	22	1%	$0.80 \pm 0.08$
C1608C0G1H220G	COG	50V	22	2%	$0.80 \pm 0.08$
C1608C0G1H470F	COG	50V	47	1%	$0.80 \pm 0.08$
C1608C0G1H470G	COG	50V	47	2%	$0.80 \pm 0.08$
C1608C0G1H101F	COG	50V	100	1%	$0.80 \pm 0.08$
C1608C0G1H101G	COG	50V	100	2%	$0.80 \pm 0.08$
C1608C0G1H221F	COG	50V	220	1%	$0.80 \pm 0.08$
C1608C0G1H221G	COG	50V	220	2%	$0.80 \pm 0.08$
C1608C0G1H471F	COG	50V	470	1%	$0.80 \pm 0.08$
C1608C0G1H471G	COG	50V	470	2%	$0.80 \pm 0.08$
C1608C0G1H102F	COG	50V	1,000	1%	$0.80 \pm 0.08$
C1608C0G1H102G	COG	50V	1,000	2%	$0.80 \pm 0.08$
C1608C0G2A101F	COG	100V	100	1%	$0.80 \pm 0.08$
C1608C0G2A101G	COG	100V	100	2%	$0.80 \pm 0.08$
C1608C0G2A102F	COG	100V	1,000	1%	$0.80 \pm 0.08$
C1608C0G2A102G	COG	100V	1,000	2%	$0.80 \pm 0.08$

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No.	Item	Performance		Test or Inspection Method			
1	External Appearance	No defects which r performance.	may affect	Inspect wi	pect with magnifying glass (3 $ imes$ ).		
2	Insulation Resistance	10,000M $\Omega$ min.		Apply rate	d voltage for 60	)s.	
3	Voltage Proof	Withstand test volt	age without	Class	Apply voltage		
		insulation breakdo	wn or other damage.	Class 1	3 × rated voltage	 ge	
						e applied for 1 to tot exceed 50mA	
4	Capacitance	Within the specifie	d tolerance.	Class	Rated Capacitance	Measuring Frequency	Measuring voltage
				Class 1	1000pF and under	1MHz±10%	- 0.5 - 5 V <sub>rms</sub>
					Over 1000pF	1kHz±10%	IIIs
5	Q	Rated Capacitance Q		See No.4	in this table for	measuring cond	dition.
	(Class 1)	C ≥ 30pF	1,000 min.				
		C < 30pF	400+20×C min.				
		C :	Rated capacitance (pF)				
6	Temperature			Temperature coefficient shall be calculated based on values at 25°C and 85°C temperature.			
	Characteristics of Capacitance			Measuring temperature below 20°C shall be -10°C and -25°C.			
	(Class 1)						
7	Robustness of Terminations		No sign of termination coming off, breakage of ceramic, or other abnormal			or on P.C. boar pushing force o	
					Capac	Pushing for P.C. boa	
8	Bending	No mechanical damage.				or on P.C. boar 2b) and bend it	
				<u> </u>	50	F R230	1

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Item	Performan	ce		Test or Inspection Method	
Solderability	New solder to cover over 75% of termination.		over 75% of	Completely soak both terminations in solder at $235\pm5^{\circ}\text{C}$ for $2\pm0.5\text{s}$ .	
	25% may ha	ve pinh	oles or rough spots	Solder: H63A (JIS Z 3282)	
	but not conce	entrated	d in one spot.	Flux: Isopropyl alcohol (JIS K 8839)	
	be exposed of	due to r	nelting or shifting of	Rosin (JIS K 5902) 25% solid solution.	
			A section		
Resistance to so	older heat			Completely soak both terminations in solder at	
External				260±5°C for 5±1s.	
appearance		ered at l	east 60% with new	Preheating condition Temp.: 150±10°C	
Canacitanas			d	Time: 1 to 2min.	
Capacitance	(ingractoristics		•	Flux: Isopropyl alcohol (JIS K 8839)	
	±2.5%		•	Rosin (JIS K 5902) 25% solid solution.	
				Solder: H63A (JIS Z 3282)	
Q (Class 1)	Rated Capacitance Q		Q	Leave the capacitor in ambient conditions for 6 to 20	
a (5.455 1)	C ≥ 30pF		1,000 min.	before measurement.	
	C < 30pF		400 + 20×C min.		
		C : F	Rated capacitance (pF)	_	
Insulation Resistance	Meet the initi	al spec	-		
Voltage	No insulation	breako	down or	-	
Proof	other damage.				
Vibration				Reflow solder the capacitor on P.C. board (shown in	
External appearance	No mechanic	al dam	age.	Appendix 1) before testing.  Vibrate the capacitor with amplitude of 1.5mm P-P	
Capacitance	Characteristics		•	sweeping the frequencies from 10Hz to 55Hz and be to 10Hz after 1min.	
	Class 1 C0	±	$2.5\%$ or $\pm 0.25$ pF,	Repeat this for 2h each in 3 perpendicular directions.	
Q (Class 1)	Rated Capa	citance	Q	-	
	C ≥ 30pF		1,000 min.		
	$\begin{array}{c c} C \geq 30 \text{pF} & 1,000 \text{ min.} \\ \hline C < 30 \text{pF} & 400 + 20 \times C \text{ min.} \end{array}$				
	Resistance to so External appearance  Capacitance  Q (Class 1)  Insulation Resistance  Voltage Proof  Vibration  External appearance  Capacitance	Solderability  New solder to termination.  25% may har but not concerning surface exposed of termination in the exposed of te	Solderability  New solder to cover termination.  25% may have pinh but not concentrated.  Ceramic surface of a be exposed due to refermination material.  External appearance shall be covered at a solder.  Capacitance  Characteristics  Class 1 COG Compared to solder.  Characteristics Compared to solder.  Class 1 COG Compared to solder.  Ciass 1 COG Compared to solder.  Ciass 2 Solder.  Ciass 3 Compared to solder.  Ciass 3 Compared to solder.  Ciass 4 Compared to solder.  Ciass 1 Compared to s	Solderability       New solder to cover over 75% of termination.         25% may have pinholes or rough spots but not concentrated in one spot.         Ceramic surface of A sections shall not be exposed due to melting or shifting of termination material.         External appearance       No cracks are allowed and terminations shall be covered at least 60% with new solder.         Capacitance       Characteristics       Change from the value before test         Class 1       C0G       Capacitance drift within ±2.5% or ±0.25pF, whichever larger.         Q (Class 1)       Rated Capacitance Q C ≥ 30pF 1,000 min. C < 30pF 400 + 20 × C min.	

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No.	Item	Performar	Performance			Inspection Method		
12	Temperature cycle External appearance	No mechani	ical dam	age.	Reflow solder the capacitors on a P.C. board (shows Appendix 1) before testing.  Expose the capacitor in the conditions in step 1			
	Capacitance	Characteris	og c	Change from the alue before test	<ul> <li>through step 4, and repeat 5 times consecutive.</li> <li>Leave the capacitor in ambient conditions for before measurement.</li> </ul>		•	
				$\pm$ 2.5% or $\pm$ 0.25pF, hichever larger.	Step	Temperature (°C)	Time (min.)	
			W	michever larger.	- 1	Min. operating temp. ±3	30 ± 3	
	Q (Class 1)	Rated Capa	acitance	Q	2	Reference Temp.	2-5	
		C ≥ 30pF		1,000 min.	3	Max. operating temp. $\pm$ 2	30 ± 2	
		C < 30pF		400 + 20×C min.	4	Reference Temp.	2 - 5	
			C : F	Rated capacitance (pF)		•		
	Insulation Resistance Voltage Proof	Meet the init  No insulatio damage.		down or other				
			\\		Defless	-   -   -   -   -   -   -   -   -	le e end (ele enne in	
13	Moisture Resistar External appearance	No mechani	-	age.	Reflow solder the capacitor on P.C. board (shown in Appendix 1) before testing.  Leave at temperature 40±2°C, 90 to 95%RH for 500			
	Capacitance	Characteris		Change from the alue before test		e the capacitor in ambient condition for 6 to 24h		
		Class 1 C	_ ±	Capacitance drift within $\pm$ 5% or $\pm$ 0.5pF, whichever larger.	before measurement.			
	Q (Class 1)	Rated Capa	citance	Q	-			
	,	C ≥ 30pF	icitarioe	350 min.	-			
		10pF ≤ C < 3	30pF	275 + 5/2×C min.	-			
		C < 10pF		200 + 10×C min.	_			
			C : F	Rated capacitance (pF)	-			
	Insulation Resistance	1,000M $\Omega$ min.			_			

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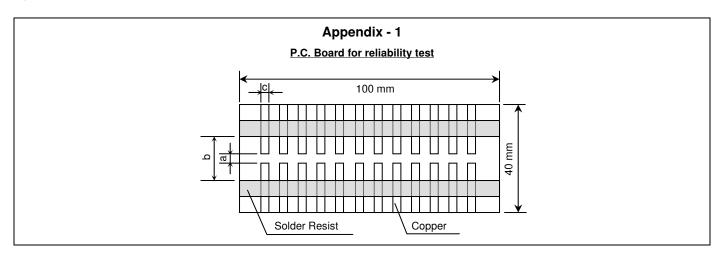
No.	Item	Perform	ance		Test or Inspection Method
14	Moisture Resistance				Reflow solder the capacitors on P.C. board (shown in Appendix 1) before testing.
	External	No mecha	anical da	ımage.	, ,
	appearance				Apply the rated voltage at temperature 40±2°C and 90— to 95%RH for 500 +24,0h.
	Capacitance	Characte	eristics	Change from the value before test	Charge/discharge current shall not exceed 50mA.
		Class 1	C0G	Capacitance drift within $\pm 7.5\%$ or $\pm 0.75 pF$ , whichever larger.	Leave the capacitor in ambient conditions for 6 to 24h before measurement.
	Q (Class 1)				Use this measurement for initial value.
	Q (Class I)		apacitano	200 min.	_
		C ≥ 30pF C < 30pF		100 + 10/3×C mir	_
		<u> </u>		: Rated capacitance (pF)	_
				. nateu capacitance (pr)	<u>'</u>
	Insulation Resistance	<b>500M</b> Ω n	nin.		
15	Life				Reflow solder the capacitor on P.C. board (shown in Appendix 1) before testing.
	External appearance	No mecha	anical da	ımage.	Apply 2x rated voltage at 125±2°C for 1,000 +48, 0h.
	Capacitance	Characte	Characteristics Change from the value before test		Charge/discharge current shall not exceed 50mA.
		Class 1	C0G	Capacitance drift within	<ul> <li>Leave the capacitors in ambient condition for 6 to 24h before measurement.</li> </ul>
				$\pm 3\%$ or $\pm 0.3$ pF,	
		-		whichever larger.	Use this measurement for initial value.
	Q (Class 1)	Rated Ca	pacitanc	e Q	_
		C ≥ 30pF	•	350 min.	_
		10pF ≤ C	< 30pF	275 + 5/2×C min.	_
		C < 10pF 2		200 + 10×C min.	_
			С	: Rated capacitance (pF)	
	Insulation Resistance	1,000M Ω	min.		

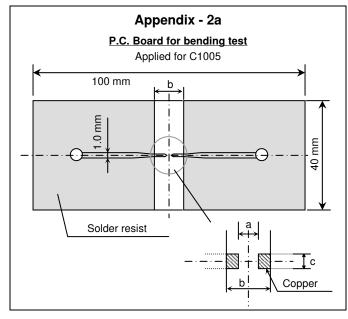
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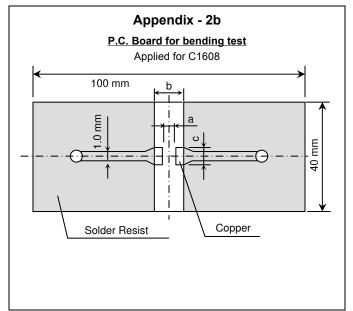
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# C Series – Tight Tolerance Capacitors







Material: Glass Epoxy (As per JIS C6484 GE4)

P.C. Board thickness: Appendix-2a 0.8mm

Appendix-1, 2b

Copper ( thickness 0.035mm )

Solder resist

Case Code		Dii	mensions (m	m)
JIS	EIA	а	b	С
C1005	CC0402	0.4	1.5	0.5
C1608	CC0603	1.0	3.0	1.2

1.6mm

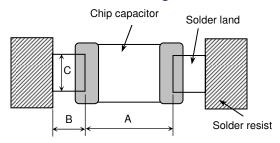
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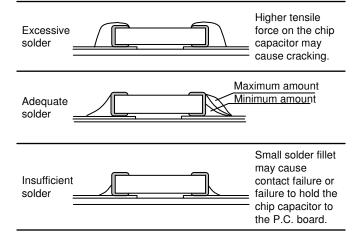
### Recommended Soldering Land Pattern



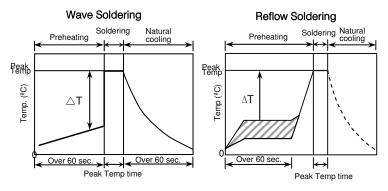
Wave Soldering	ng Unit: mm
Туре	C1608
Symbol	[CC0603]
Α	0.7 - 1.0
В	0.8 - 1.0
С	0.6 - 0.8

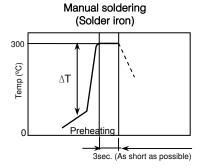
**Reflow Soldering** Unit: mm C1005 C1608 Type [CC0402] [CC0603] Symbol 0.3 - 0.50.6 - 0.8Α В 0.35 - 0.45 0.6 - 0.80.4 - 0.6 С 0.6 - 0.8

#### Recommended Solder Amount



### Recommended Soldering Profile





### **Recommended soldering duration**

Temp./	Wave S	oldering	Reflow Soldering		
Dura. Solder	Peak temp (°C)	Duration (sec.)	Peak temp (°C)	Duration (sec.)	
Sn-Pb Solder	250 max.	3 max.	230 max.	20 max.	
Lead-Free Solder	260 max.	5 max.	260 max.	10 max.	

Recommended solder compositions

Sn-37Pb (Sn-Pb solder)

Sn-3.0Ag-0.5Cu (Lead Free Solder)

### **Preheating Condition**

Soldering	Case Size - JIS (EIA)	Temp. (ºC)
Wave soldering	C1608(CC0603)	ΔT ≤ 150
Reflow soldering	C1005(CC0402), C1608(CC0603)	ΔT ≤ 150
Manual soldering	C1005(CC0402), C1608(CC0603)	ΔT ≤ 150

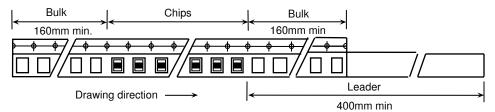
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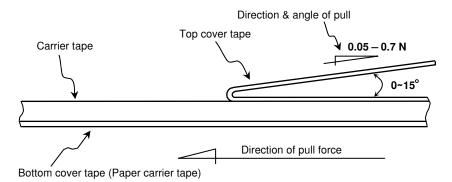


# C Series – Tight Tolerance Capacitors

### Carrier Tape Configuration

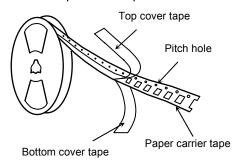


### • Peel Back Force (Top Tape)



### · Chip Quantity Per Reel and Structure of Reel

### Paper Carrier Tape & Reel



Case Code		Chip	Toning	Chip quantity (pcs.)		
JIS	EIA	Thickness (mm)	Taping Material	φ178mm (7") reel	φ330mm (13") reel	
C1005	CC0402	0.50	Danar	10,000	50,000	
C1608	CC0603	0.80	Paper	4,000	10,000	

- Carrier tape shall be flexible enough to be wound around a minimum radius of 30mm with components in tape.
- The missing of components shall be less than 0.1%
- · Components shall not stick to the cover tape.
- The cover tape shall not protrude beyond the edges of the carrier tape and shall not cover the sprocket holes.

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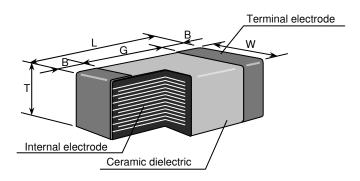
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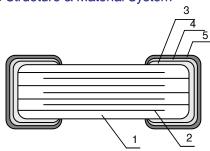
## C Series – Tight Tolerance Capacitors

### Shape & Dimensions



Case Code		Dimensions (mm)					
JIS	EIA	L	W	Т	В	G	
C1005	CC0402	1.00	0.50	0.50	0.25	0.35 min.	
C1608	CC0603	1.60	0.80	0.80	0.20 min.	0.50 min.	

### Inside Structure & Material System



No.	NAME	MATERIAL		
		Class 1		
(1)	Ceramic Dielectric	CaZrO <sub>3</sub>		
(2)	Internal Electrode	Nickel (Ni)		
(3)		Copper (Cu)		
(4)	Termination	Nickel (Ni)		
(5)		Tin (Sn)		

#### Environmental Information

TDK Corporation established internal product environmental assurance standards that include the six hazardous substances banned by the EU RoHS Directive¹ enforced on July 1, 2006 along with additional substances independently banned by TDK and has successfully completed making general purpose electronic components conform to the RoHS Directive².

- Abbreviation for Restriction on Hazardous Substances, which refers to the regulation EU Directive 2002/95/EC on hazardous substances by the European Union (EU) effective from July 1, 2006. The Directive bans the use of six specific hazardous substances in electric and electronic devices and products handled within the EU. The six substances are lead, mercury, cadmium, hexavalent chromium, PBB (polybrominated biphenyls), and PBDE (polybrominated diphenyl ethers).
- This means that, in conformity with the EU Directive 2002/95/EC, lead, cadmium, mercury, hexavalent chromium, and specific bromine-based flame retardants, PBB and PBDE, have not been used, except for exempted applications.

For REACH (SVHC: 15 substances according to ECHA / October 2008): All TDK MLCC do not contain these 15 substances.

For European Directive 2000/53/CE and 2005/673/CE:
Cadmium, Hexavalent Chromium, Mercury, Lead are not contained in all TDK MLCC.

For European Directive 2003/11/CE: Pentabromodiphenyl-ether, Octabromodiphenyl-ether are not contained in all TDK MLCC.

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